Hindawi Advances in Materials Science and Engineering Volume 2023, Article ID 9798589, 1 page https://doi.org/10.1155/2023/9798589



Retraction

Retracted: The Silver Ion and Nanocrystalline Pattern in the Glass Substrate, the Electric Field-Induced Thermal Transfer and Ink Absorption Layer Structure and Printing Performance

Advances in Materials Science and Engineering

Received 26 December 2023; Accepted 26 December 2023; Published 29 December 2023

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This article has been retracted by Hindawi, as publisher, following an investigation undertaken by the publisher [1]. This investigation has uncovered evidence of systematic manipulation of the publication and peer-review process. We cannot, therefore, vouch for the reliability or integrity of this article.

Please note that this notice is intended solely to alert readers that the peer-review process of this article has been compromised.

Wiley and Hindawi regret that the usual quality checks did not identify these issues before publication and have since put additional measures in place to safeguard research integrity.

We wish to credit our Research Integrity and Research Publishing teams and anonymous and named external researchers and research integrity experts for contributing to this investigation.

The corresponding author, as the representative of all authors, has been given the opportunity to register their agreement or disagreement to this retraction. We have kept a record of any response received.

References

[1] C. Dong, "The Silver Ion and Nanocrystalline Pattern in the Glass Substrate, the Electric Field-Induced Thermal Transfer and Ink Absorption Layer Structure and Printing Performance," *Advances in Materials Science and Engineering*, vol. 2022, Article ID 4272294, 10 pages, 2022.